

8-pin Dual-Channel Phototransistor Optocouplers

MCT6, MCT61, MCT62

Description

The general purpose optocouplers, MCT6, MCT61, and MCT62, have two isolated channels in a standard plastic 8-pin dual-in-line (DIP) package for density applications. Each channel consists of a gallium arsenide infrared emitting diode driving a NPN silicon planar phototransistor. For four channel applications, two packages fit into a standard 16-pin DIP socket.

Features

- Two Isolated Channels Per Package
- Safety and Regulatory Approvals:
 - UL1577, 5,000 VAC_{RMS} for 1 Minute
 - DIN-EN/IEC60747-5-5, 890 V Peak Working Insulation Voltage
- These are Pb-Free Devices

Applications

- AC Line/Digital Logic – Isolate High Voltage Transients
- Digital Logic/Digital Logic – Eliminate Spurious Grounds
- Digital Logic/AC Triac Control – Isolate High Voltage Transients
- Twisted Pair Line Receiver – Eliminate Ground Loop Feedthrough
- Telephone/Telephone Line Receiver – Isolate High Voltage Transients
- High Frequency Power Supply Feedback Control– Maintain Floating Grounds and Transients
- Relay Contact Monitor – Isolate Floating Grounds and Transients
- Power Supply Monitor – Isolate Transients

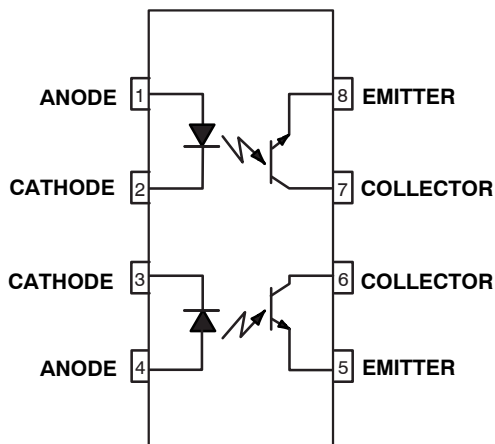
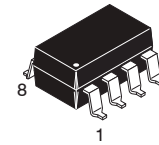
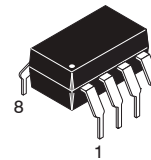


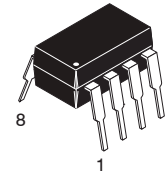
Figure 1. Schematic



PDIP8 GW
CASE 709AF

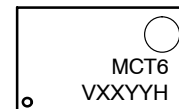


PDIP8 9.68x6.5,
2.54P
CASE 646CJ



PDIP8 9.655x6.6,
2.54P
CASE 646CQ

MARKING DIAGRAM



MCT6 = Specific Device Code
 V = DIN EN/IEC 60747-5-5 option
 (only appears on component ordered with this option)
 XX = Two Digit Year Code, e.g., "16"
 YY = Digit Work Week Ranging from "01" to "53"
 H = Assembly Package Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

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Safety and Insulation Ratings

As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for “safe electrical insulation” only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Parameter		Characteristics
Installation Classifications per DIN VDE 0110/1.89 Table 1, For Rated Mains Voltage	< 150 V _{RMS}	I–IV
	< 300 V _{RMS}	I–III
Climatic Classification		55/100/21
Pollution Degree (DIN VDE 0110/1.89)		2
Comparative Tracking Index		175

Symbol	Parameter	Value	Unit
V _{PR}	Input-to-Output Test Voltage, Method A, V _{IORM} × 1.6 = V _{PR} , Type and Sample Test with t _m = 10 s, Partial Discharge < 5 pC	1424	V _{peak}
	Input-to-Output Test Voltage, Method B, V _{IORM} × 1.875 = V _{PR} , 100% Production Test with t _m = 1 s, Partial Discharge < 5 pC	1668	V _{peak}
V _{IORM}	Maximum Working Insulation Voltage	890	V _{peak}
V _{IOTM}	Highest Allowable Over-Voltage	8000	V _{peak}
	External Creepage	≥7	mm
	External Clearance	≥7	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥0.4	mm
T _S	Case Temperature (Note 1)	175	°C
I _{S,INPUT}	Input Current (Note 1)	60	mA
P _{S,OUTPUT}	Output Power (Note 1)	150	mW
R _{IO}	Insulation Resistance at T _S , V _{IO} = 500 V (Note 1)	>10 ⁹	Ω

1. Safety limit values – maximum values allowed in the event of a failure.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Rating	Value	Unit
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TOTAL DEVICE

T _{STG}	Storage Temperature	–55 to +150	°C
T _{OPR}	Operating Temperature	–55 to +100	°C
T _J	Junction Temperature	–55 to +125	°C
T _{SOL}	Lead Solder Temperature	260 for 10 seconds	°C
P _D	Total Device Power Dissipation @ T _A = 25°C	400	mW
	Derate Above 25°C	5.33	mW/°C

EMITTER (Each channel)

I _F	DC / Average Forward Input Current	60	mA
I _{F(pk)}	Forward Current – Peak (PW = 1 μs, 300 pps)	3	A
V _R	Reverse Input Voltage	3	V
P _{D(EMITTER)}	Total Power Dissipation @ T _A = 25°C	100	mW
	Derate Above 25°C	1.3	mW/°C

DETECTOR

I _C	Continuous Collector Current	30	mA
P _{D(DETECTOR)}	Total Power Dissipation @ T _A = 25°C	150	mW
	Derate Above 25°C	2.0	mW/°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
EMITTER						
V_F	Input Forward Voltage	$I_F = 20\text{ mA}$	–	1.2	1.5	V
V_R	Reverse Voltage	$I_R = 10\text{ }\mu\text{A}$	3	25	–	V
I_R	Reverse Leakage Current	$V_R = 5\text{ V}$	–	0.001	10	μA
C_J	Junction Capacitance	$V_F = 0\text{ V}$, $f = 1\text{ MHz}$	–	50	–	pF

DETECTOR

BV_{CEO}	Collector-to-Emitter Breakdown Voltage	$I_C = 1.0\text{ mA}$, $I_F = 0$	30	85	–	V
BV_{ECO}	Emitter-to-Collector Breakdown Voltage	$I_E = 100\text{ }\mu\text{A}$, $I_F = 0$	6	13	–	V
I_{CEO}	Collector-to-Emitter Dark Current	$V_{CE} = 10\text{ V}$, $I_F = 0$	–	5	100	nA
C_{CE}	Capacitance	$V_{CE} = 0\text{ V}$, $f = 1\text{ MHz}$	–	8	–	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Transfer Characteristics

Symbol	Parameter	Device	Test Conditions	Min	Typ	Max	Unit
DC CHARACTERISTICS							
C_{TR}	Current Transfer Ratio, Collector-to-Emitter	MCT6	$I_F = 10\text{ mA}$, $V_{CE} = 10\text{ V}$	20	–	–	%
		MCT61	$I_F = 5\text{ mA}$, $V_{CE} = 5\text{ V}$	50	–	–	
		MCT62		100	–	–	
$V_{CE(SAT)}$	Saturation Voltage, Collector-to-Emitter	ALL	$I_F = 16\text{ mA}$, $I_C = 2\text{ mA}$	–	0.15	0.4	V

AC CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Non-Saturated						
t _{on}	Turn-On Time	R _L = 100 Ω, I _C = 2 mA, V _{CC} = 10 V	–	3.0	–	μs
t _{off}	Turn-Off Time		–	3.0	–	μs
t _r	Rise Time		–	2.4	–	μs
t _f	Fall Time		–	2.4	–	μs
Saturated						
t _{on}	Turn-On Time	I _F = 16 mA, R _L = 1.9 kΩ, V _{CE} = 5 V	–	2.4	–	μs
t _{off}	Turn-Off Time		–	25.0	–	μs

Isolation Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{ISO}	Input-Output Isolation Voltage	$I_{I-O} \leq 10\text{ }\mu\text{A}$, $t = 1\text{ Minute}$	5,000	–	–	$V_{AC_{RMS}}$
C_{ISO}	Isolation Capacitance	$f = 1\text{ MHz}$	–	0.5	–	pF
R_{ISO}	Isolation Resistance	$V_{I-O} = 500\text{ VDC}$	10^{11}	–	–	Ω

TYPICAL PERFORMANCE CURVES

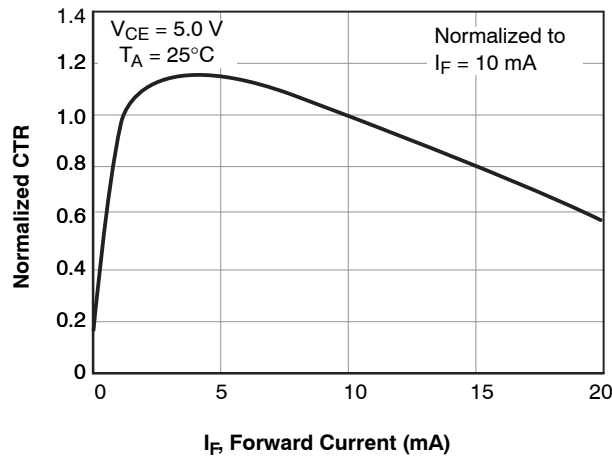


Figure 2. Normalized CTR vs. Forward Current

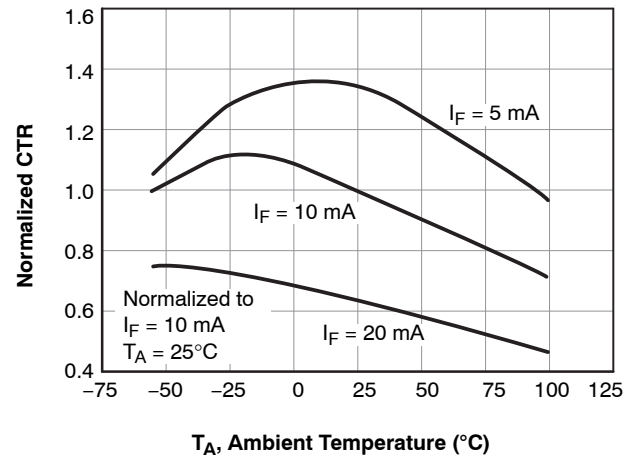


Figure 3. Normalized CTR vs. Ambient Temperature

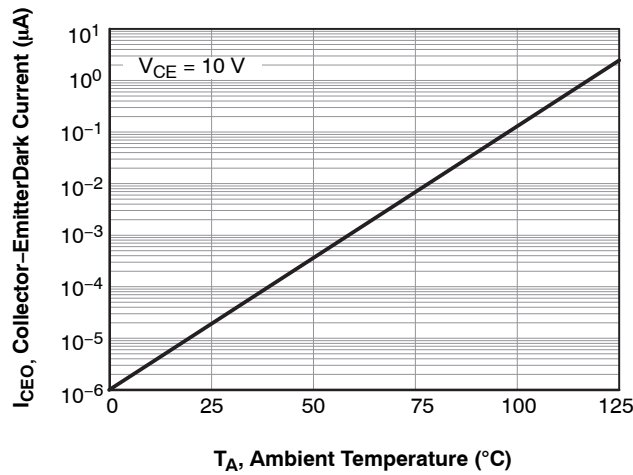


Figure 4. Dark Current vs. Ambient Temperature

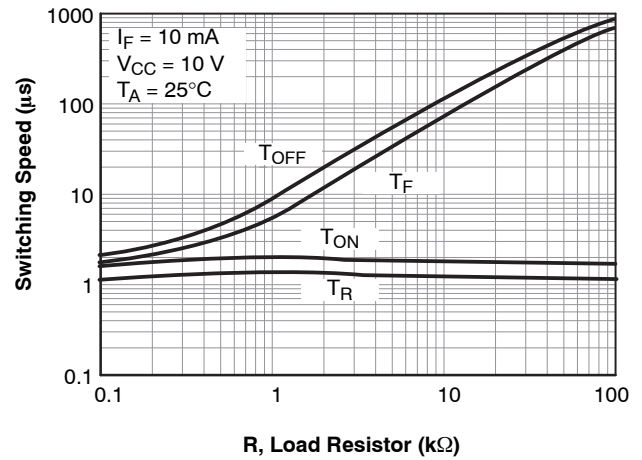


Figure 5. Switching Speed vs. Load Resistor

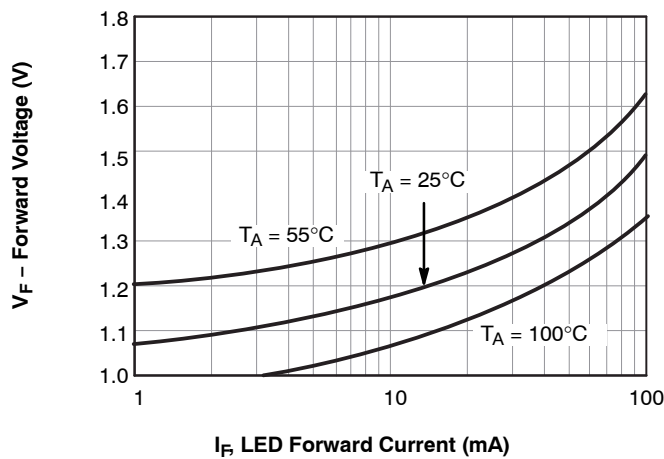


Figure 6. LED Forward Voltage vs. Forward Current

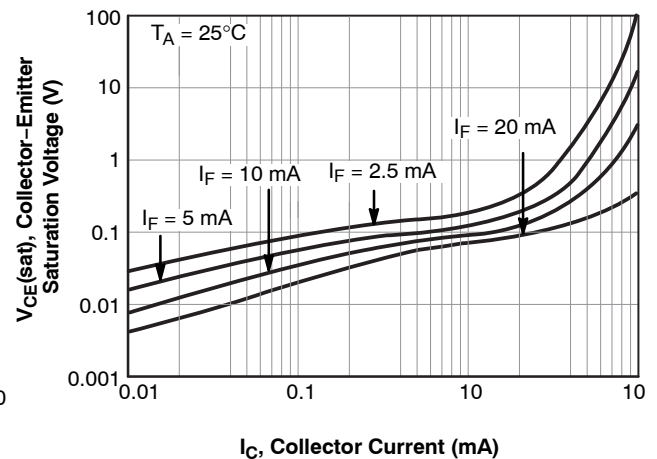


Figure 7. Collector-Emitter Saturation Voltage vs. Collector Current

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SWITCHING TIME TEST CIRCUIT AND WAVEFORMS

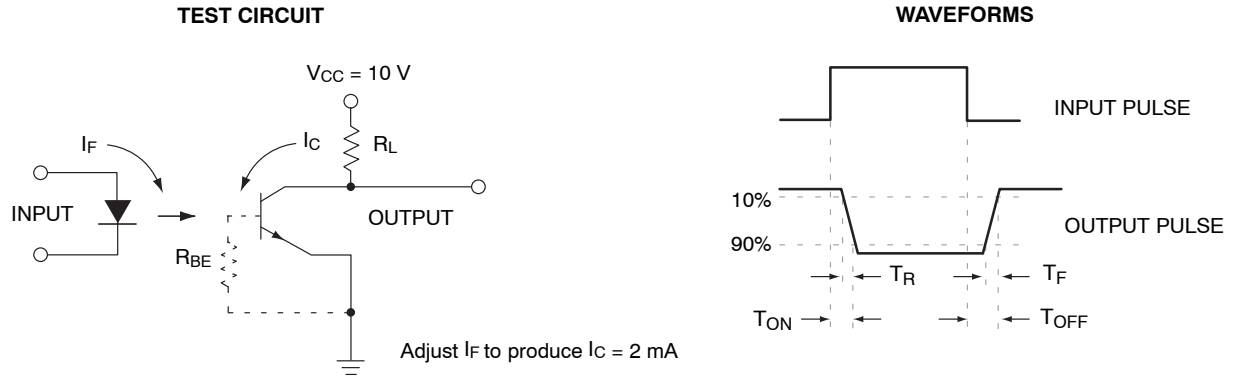


Figure 8. Switching Time Test Circuit and Waveforms

REFLOW PROFILE

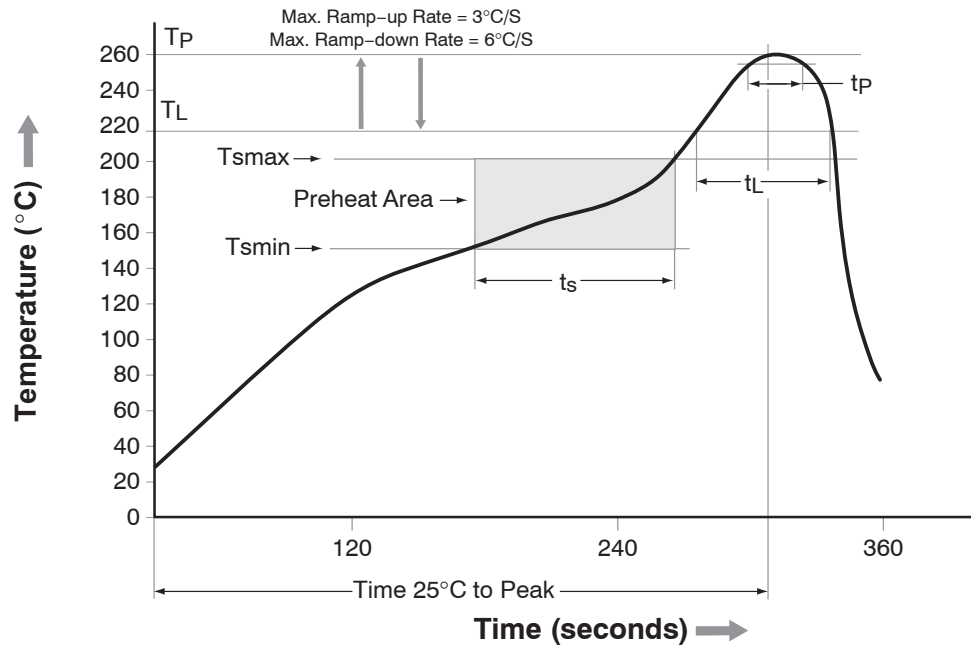


Figure 9. Reflow Profile

Profile Feature	Pb-Free Assembly Profile
Temperature Minimum (T_{smin})	150°C
Temperature Maximum (T_{smx})	200°C
Time (t_s) from (T_{smin} to T_{smx})	60 – 120 seconds
Ramp-up Rate (t_L to t_p)	3°C/second maximum
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds
Peak Body Package Temperature	$260^{\circ}\text{C} + 0^{\circ}\text{C} / -5^{\circ}\text{C}$
Time (t_p) within 5°C of 260°C	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second maximum
Time 25°C to Peak Temperature	8 minutes maximum

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ORDERING INFORMATION

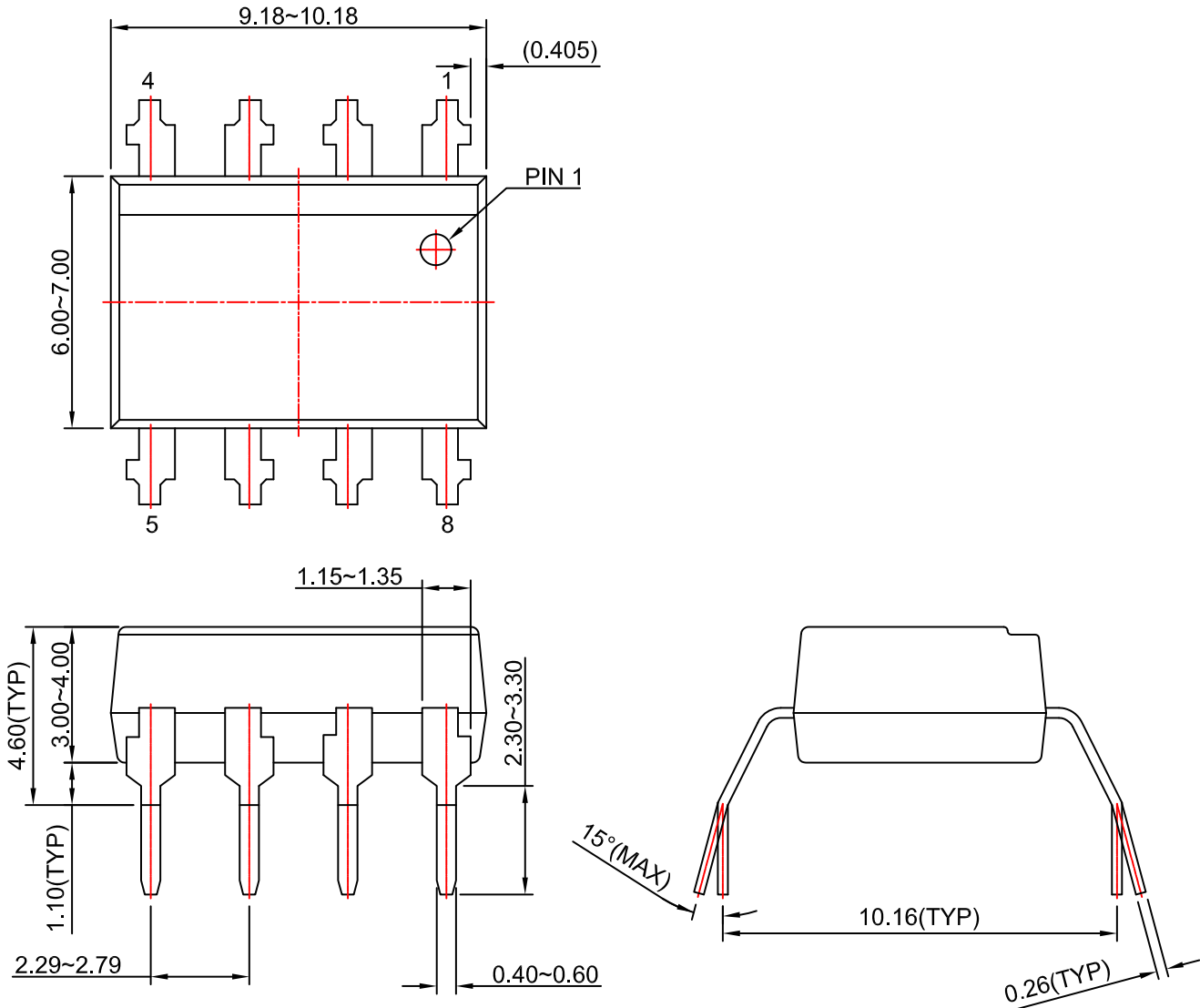
Part Number	Package	Packing Method [†]
MCT6	DIP 8-Pin	50 Units / Tube
MCT6S	SMT 8-Pin (Lead Bend)	50 Units / Tube
MCT6SD	SMT 8-Pin	1,000 Units / Tape & Reel
MCT6300	DIN EN/IEC 60747-5-5 Option	50 Units / Tube
MCT63S	SMT 8-Pin (Lead Bend); DIN EN/IEC 60747-5-5 Option	50 Units / Tube
MCT63SD	SMT 8-Pin; DIN EN/IEC 60747-5-5 Option	1,000 Units / Tape & Reel
MCT6300W	0.4" Lead Spacing; DIN EN/IEC 60747-5-5 Option	50 Units / Tube

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

NOTE: The product orderable part number system listed in this table also applies to the MCT61 and MCT62.

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CASE 646CJ
ISSUE O

DATE 31 JUL 2016



NOTES:

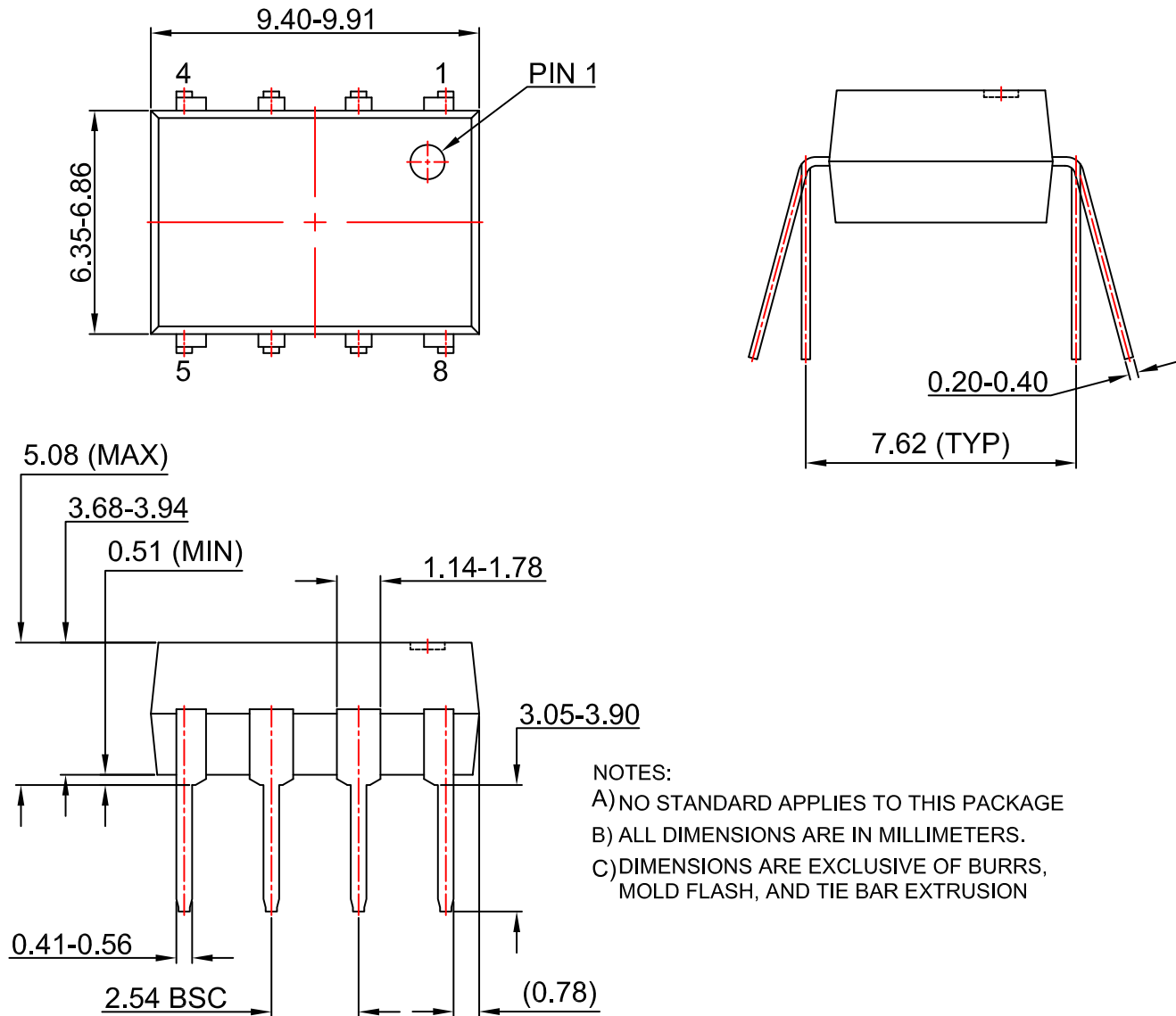
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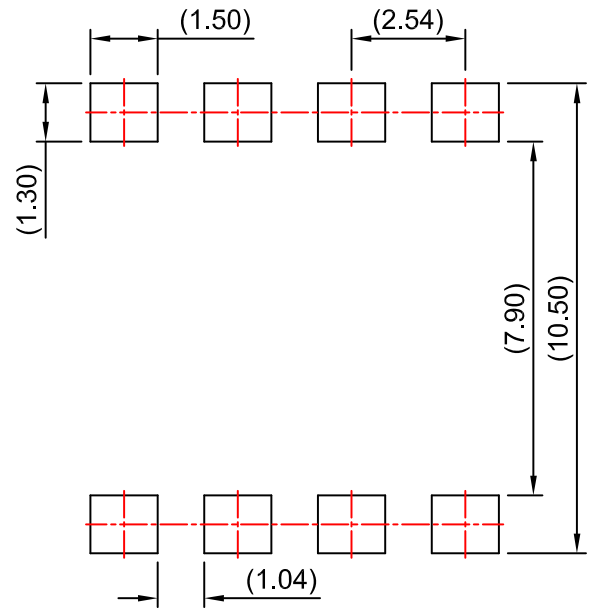
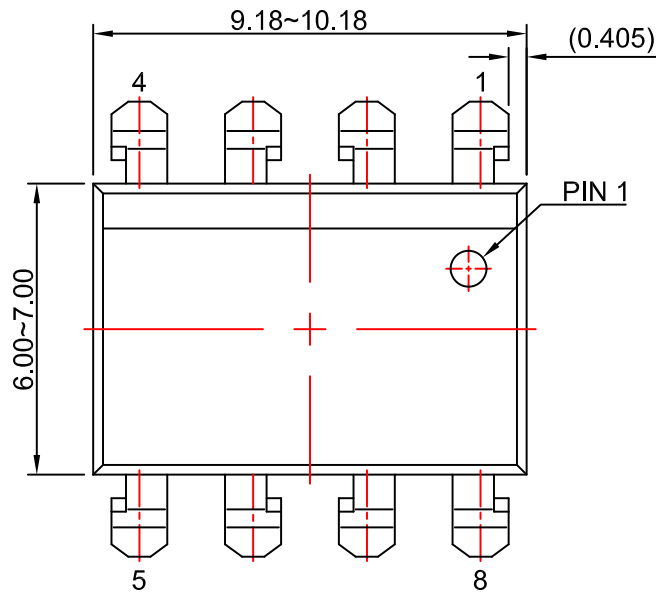


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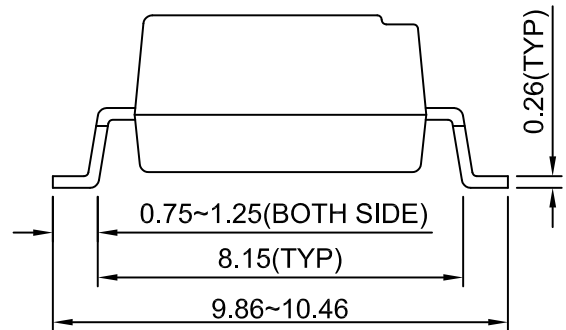
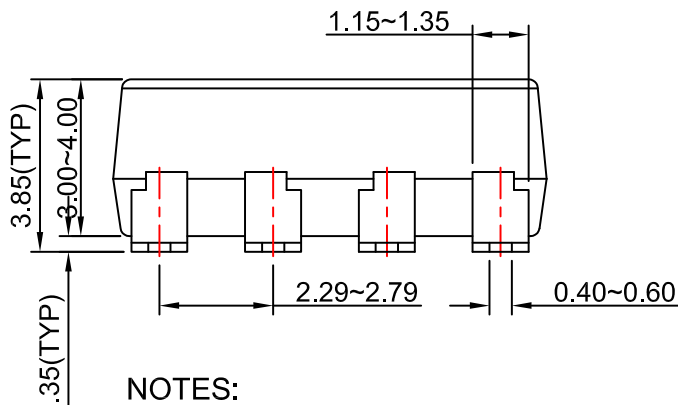
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